Serial-In Parallel-Out **Shift Register**

The SN74LS164 is a high speed 8-Bit Serial-In Parallel-Out Shift Register. Serial data is entered through a 2-Input AND gate synchronous with the LOW to HIGH transition of the clock. The device features an asynchronous Master Reset which clears the register setting all outputs LOW independent of the clock. It utilizes the Schottky diode clamped process to achieve high speeds and is fully compatible with all ON Semiconductor TTL products.

- Typical Shift Frequency of 35 MHz
- Asynchronous Master Reset
- Gated Serial Data Input
- Fully Synchronous Data Transfers
- Input Clamp Diodes Limit High Speed Termination Effects
- ESD > 3500 Volts

GUARANTEED OPERATING RANGES

Symbol	Symbol Parameter		Тур	Max	Unit
V _{CC}	Supply Voltage	4.75	5.0	5.25	V
T _A	Operating Ambient Temperature Range	0	25	70	°C
I _{OH}	Output Current – High			-0.4	mA
I _{OL}	Output Current – Low			8.0	mA



ON Semiconductor

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LOW **POWER SCHOTTKY**



PLASTIC N SUFFIX CASE 646



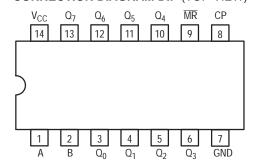
SOIC **D SUFFIX CASE 751A**

ORDERING INFORMATION

Device	Package	Shipping		
SN74LS164N	14 Pin DIP	2000 Units/Box		
SN74LS164D	14 Pin	2500/Tape & Reel		



CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-Line Package.

PIN NAMES

 $\begin{array}{lll} \text{A, B} & \text{Data Inputs} \\ \text{CP} & \text{Clock (Active HIGH Going Edge) Input} \\ \hline \text{MR} & \text{Master Reset (Active LOW) Input} \\ \text{Q}_0 - \text{Q}_7 & \text{Outputs} \end{array}$

HIGH LOW

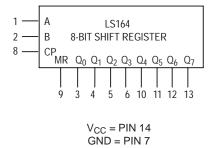
0.5 U.L. 0.25 U.L.
0.5 U.L. 0.25 U.L.
0.5 U.L. 0.25 U.L.
10 U.L. 5 U.L.

LOADING (Note a)

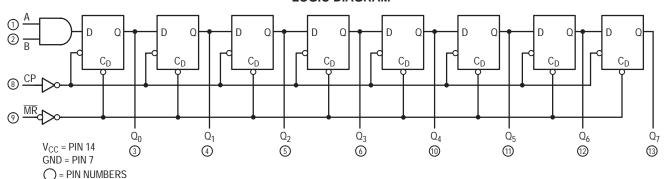
NOTES:

a) 1 TTL Unit Load (U.L.) = 40 μ A HIGH/1.6 mA LOW.

LOGIC SYMBOL



LOGIC DIAGRAM



FUNCTIONAL DESCRIPTION

The LS164 is an edge-triggered 8-bit shift register with serial data entry and an output from each of the eight stages. Data is entered serially through one of two inputs (A or B); either of these inputs can be used as an active HIGH Enable for data entry through the other input. An unused input must be tied HIGH, or both inputs connected together.

Each LOW-to-HIGH transition on the Clock (CP) input shifts data one place to the right and enters into Q_0 the logical AND of the two data inputs (A•B) that existed before the rising clock edge. A LOW level on the Master Reset (\overline{MR}) input overrides all other inputs and clears the register asynchronously, forcing all Q outputs LOW.

MODE SELECT — TRUTH TABLE

OPERATING		INPUTS		OUTPUTS	
MODE	MR	Α	В	Q_0	Q ₁ –Q ₇
Reset (Clear)	L	Х	Х	L	L-L
Shift	пппп	I I h h	 h h	L L I	q ₀ - q ₆ q ₀ - q ₆ q ₀ - q ₆ q ₀ - q ₆

L (I) = LOW Voltage Levels H (h) = HIGH Voltage Levels

X = Don't Care

 q_{n} = Lower case letters indicate the state of the referenced input or output one set-up time prior to the LOW to HIGH clock transition.

DC CHARACTERISTICS OVER OPERATING

TEMPERATURE RANGE (unless otherwise specified)

		Limits						
Symbol	Parameter	Min	Тур	Max	Unit	Test C	onditions	
V _{IH}	Input HIGH Voltage	2.0			V	Guaranteed Input HIGH Voltage for All Inputs		
V _{IL}	Input LOW Voltage			0.8	V	Guaranteed Input LOW Voltage for All Inputs		
V _{IK}	Input Clamp Diode Voltage		-0.65	-1.5	V	V _{CC} = MIN, I _{IN} = -18 mA		
V _{OH}	Output HIGH Voltage	2.7	3.5		V	V_{CC} = MIN, I_{OH} = MAX, V_{IN} = V_{IH} or V_{IL} per Truth Table		
	0 / / 0 / / /		0.25	0.4	V	I _{OL} = 4.0 mA	$V_{CC} = V_{CC} MIN,$	
V _{OL}	Output LOW Voltage		0.35	0.5	V	I _{OL} = 8.0 mA	$V_{IN} = V_{IH}$ or V_{IL} per Truth Table	
	L			20	μΑ	V _{CC} = MAX, V _{IN} :	$V_{CC} = MAX, V_{IN} = 2.7 V$	
lн	Input HIGH Current			0.1	mA	$V_{CC} = MAX, V_{IN} = 7.0 V$		
I _{IL}	Input LOW Current			-0.4	mA	$V_{CC} = MAX$, $V_{IN} = 0.4 V$		
I _{OS}	Short Circuit Current (Note 1)	-20		-100	mA	V _{CC} = MAX		
I _{CC}	Power Supply Current	T		27	mA	V _{CC} = MAX		

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

AC CHARACTERISTICS $(T_A = 25^{\circ}C)$

		Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions	
f _{MAX}	Maximum Clock Frequency	25	36		MHz	V _{CC} = 5.0 V C _L = 15 pF	
t _{PHL}	Propagation Delay MR to Output Q		24	36	ns		
t _{PLH}	Propagation Delay Clock to Output Q		17 21	27 32	ns		

AC SETUP REQUIREMENTS $(T_A = 25^{\circ}C)$

			Limits				
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions	
t _W	CP, MR Pulse Width	20			ns		
ts	Data Setup Time	15			ns	V	
t _h	Data Hold Time	5.0			ns	V _{CC} = 5.0 V	
t _{rec}	MR to Clock Recovery Time	20			ns		



AC WAVEFORMS

*The shaded areas indicate when the input is permitted to change for predictable output performance.

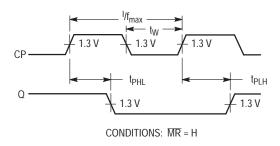


Figure 1. Clock to Output Delays and Clock Pulse Width

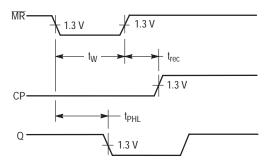


Figure 2. Master Reset Pulse Width, Master Reset to Output Delay and Master Reset to Clock Recovery Time

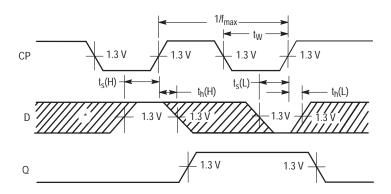
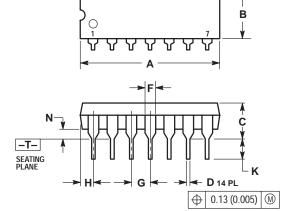


Figure 3. Data Setup and Hold Times

PACKAGE DIMENSIONS

N SUFFIX PLASTIC PACKAGE CASE 646-06 ISSUE M



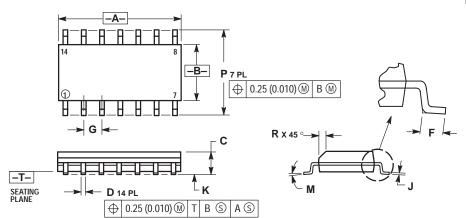


- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	OIM MIN MAX		MIN	MAX	
Α	0.715	0.770	18.16	18.80	
В	0.240	0.260	6.10	6.60	
С	0.145	0.185	3.69	4.69	
D	0.015	0.021	0.38	0.53	
F	0.040	0.070	1.02	1.78	
G	0.100	BSC	2.54	BSC	
Н	0.052	0.095	1.32	2.41	
٦	0.008	0.015	0.20	0.38	
K	0.115	0.135	2.92	3.43	
L	0.290	0.310	7.37	7.87	
M		10°		10°	
N	0.015	0.039	0.38	1.01	

D SUFFIX PLASTIC SOIC PACKAGE

CASE 751A-03 ISSUE F



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 5. DIMENSION D DOES NOT INCLUDE DAMBAR

DIMENSION D DOES NOT INCLUDE DAMBAR
PROTRUSION. ALLOWABLE DAMBAR
PROTRUSION SHALL BE 0.127 (0.005) TOTAL
IN EXCESS OF THE D DIMENSION AT
MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	8.55	8.75	0.337	0.344	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.25	0.016	0.049	
G	1.27	BSC	0.050	0 BSC	
J	0.19	0.25	0.008	0.009	
K	0.10	0.25	0.004	0.009	
M	0 °	7°	0 °	7°	
P	5.80	6.20	0.228	0.244	
R	0.25	0.50	0.010	0.019	

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Email: ONlit-asia@hibbertco.com

JAPAN: ON Semiconductor, Japan Customer Focus Center 4–32–1 Nishi–Gotanda, Shinagawa–ku, Tokyo, Japan 141–8549

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